

Datasheet revision 1.0

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Sn42/Bi57/Ag1 .047" Solid Core Solder Wire 4oz Spool

Product Highlights LOW TEMPERATURE Melts at 138°C (281°F) Lead-Free RoHS III and REACH compliant

Specifications

Alloy: Wire diameter: Melting Point: Packaging: Sn42/Bi57/Ag1 0.047" (1.2mm) 138°C (281°F) 4oz Spool



Yes

Storage and Handling Store in a non-corrosive, dry environment.

Please Note: Although Sn42/Bi57/Ag1 forms strong joints and is more ductile due to the added 1% Silver, in wire form it is brittle and needs to be handled gently when unspooling. It is normal for spooled Sn42/Bi57/Ag1 wire to have some breaks in it.

Test Results

Test Requirement	Result
Electronic Industry Citizenship Coalition (EICC)	Compliant
Articles 33 and 67 of Regulation (EC) No 1907/2006	Contains no substance >0.1% w/w that is listed as a SVHC or restricted for use in solder materials
	Electronic Industry Citizenship Coalition (EICC) Articles 33 and 67 of Regulation (EC)

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders): RoHS 3 Directive (EU) 2015/863: